



DIP318-011BLF Information

Heisener.com

Part Number DIP318-011BLF Manufacturer Amphenol FCI

Category Connectors, Interconnects

Sockets for ICs, Transistors

Description CONN IC DIP SOCKET 18POS GOLD

Package

For the pricing/inventory/lead time, please contact

Website: https://www.heisener.com For Reference Only

E-mail: salesdept@heisener.com



Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.









DIP318-011BLF Specifications

Manufacturer Part Number	DIP318-011BLF
Manufacturer	Amphenol FCI
Category	Connectors, Interconnects
	Sockets for ICs, Transistors
Package	-
Series	-
Туре	DIP, 0.3" (7.62mm) Row Spacing
Number of Positions or Pins (Grid)	18 (2 x 9)
Pitch - Mating	0.100" (2.54mm)
Contact Finish - Mating	Gold
Contact Finish Thickness - Mating	10μin (0.25μm)
Contact Material - Mating	Beryllium Copper
Mounting Type	Through Hole
Features	Open Frame
Termination	Solder
Pitch - Post	0.100" (2.54mm)
Contact Finish - Post	Tin
Contact Finish Thickness - Post	200μin (5.08μm)
Contact Material - Post	Brass
Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester, Glass Filled
Operating Temperature	-
	Report errors?

DIP318-011BLF Guarantees



Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

DIP318-011BLF Payment Methods



















DIP318-011BLF Shipping Methods













If you have any question about DIP318-011BLF, please do not hesitate to contact us!

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